

. . eescale Semiconductor

Technical Data

MHL18926 Rev. 3, 1/2005

Replaced by MHL18926N. There are no form, fit or function changes with this part replacement. N suffix added to part number to indicate transition to lead-free terminations

PCS Band RF Linear LDMOS Amplifier

Designed for ultra-linear amplifier applications in 50 ohm systems operating in the PCS frequency band. A silicon FET Class A design provides outstanding linearity and gain. In addition, the excellent group delay and phase linearity characteristics are ideal for digital modulation systems, such as TDMA, GSM EDGE and CDMA.

- Third Order Intercept Point: 50 dBm Typ
- Power Gain: 28.6 dB Typ (@ f = 1842 MHz)
- · Excellent Phase Linearity and Group Delay Characteristics
- Ideal for Feedforward Base Station Application

MHL18926

1805-1880 MHz, 10 W, 28.6 dB RF LINEAR LDMOS AMPLIFIER

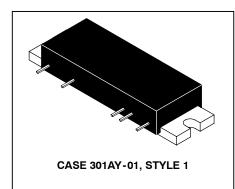


Table 1. Absolute Maximum Ratings (T_C = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
DC Supply Voltage	V_{DD}	30	Vdc
RF Input Power	P _{in}	+18	dBm
Storage Temperature Range	T _{stg}	- 40 to +100	°C
Operating Case Temperature Range	T _C	- 20 to +100	°C

Table 2. Electrical Characteristics ($T_C = +25^{\circ}C$; $V_{DD} = 26 \text{ Vdc}$; 50 Ω System)

Character	Symbol	Min	Тур	Max	Unit	
Supply Current		I _{DD}	_	1.1	1.15	А
Power Gain	(f = 1842 MHz)	G _p	27.6	28.6	29.6	dB
Gain Flatness	(f = 1805-1880 MHz)	G _F	_	0.3	0.5	dB
Power Output @ 1 dB Compression	(f = 1842 MHz)	P1 dB	39	40	_	dBm
Input VSWR	(f = 1805-1880 MHz)	VSWR _{in}	_	1.2:1	1.5:1	
Third Order Intercept	(f1 =1839 MHz, f2=1844 MHz)	ITO	49.5	50	_	dBm
Noise Figure	(f = 1880 MHz)	NF	_	4.2	5	dB

NOTE - <u>CAUTION</u> - MOS devices are susceptible to damage from electrostatic charge. Reasonable precautions in handling and packaging MOS devices should be observed.



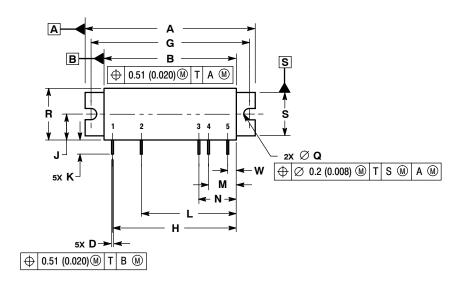


NOTES



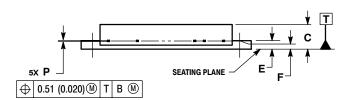
ARCHIVE INFORMATION

PACKAGE DIMENSIONS



ES: CONTROLLING DIMENSION: MILLIMETER. INTERPRET DIMENSIONS AND TOLERANC PER ANSI Y14.5M, 1982. DIMENSION F TO CENTER LINE OF LEADS					
	MILLIN	IETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
Α	44.7	45.21	1.760	1.780	
В	34.8	35.31	1.370	1.390	
С	6.22	6.73	0.245	0.265	
D	0.43	0.58	0.017	0.023	
E	2.03	2.54	0.080	0.100	
F	2.18 BSC		0.086 BSC		
G	41.91 BSC		1.650 BSC		
Н	32.77 BSC		1.290 BSC		
J	6.76	7.11	0.266	0.280	
K	3.18	4.19	0.125	0.165	
L	25.15	BSC	0.990 BSC		
M	7.37	BSC	0.290 BSC		
N	9.91 BSC		0.390 BSC		
Р	0.2	0.33	0.008	0.013	
Q	3	3.35	0.118	0.132	
R	13.59	14.1	0.535	0.555	
S	11.3	11.81	0.445	0.465	
w	2.29	BSC	0.090 BSC		

STYLE 1:
PIN 1. RF INPUT
2. VDD1
3. VDD2
4. VDD3
5. RF OUTPUT
CASE: GROUND



CASE 301AY-01 ISSUE O

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